

### FEATURES

- High Voltage Operation :  $V_{DS}=50V$
- High Power : 53.5dBm (typ.) @  $P_{sat}$
- High Efficiency : 70%(typ.) @  $P_{sat}$
- Power Gain : 17.5dB (typ.) @  $f=0.9GHz$
- Proven Reliability

### DESCRIPTION

SEI's GaN-HEMT offers high efficiency, ease of matching, greater consistency and broad bandwidth for high power L-band amplifiers with 50V operation, and gives you higher gain.

This new product is ideally suited for use in 0.9GHz LTE design requirements as it offers high gain, long term reliability and ease of use.



### ABSOLUTE MAXIMUM RATINGS ( Case Temperature $T_c=25deg.C$ )

Item	Symbol	Condition	Rating	Unit
Operating Voltage	$V_{DS}$		55	V
Drain-Source Voltage	$V_{DS}$	$V_{GS}=-8V$	160	V
Gate-Source Voltage	$V_{GS}$		-15	V
Total Power Dissipation	$P_t$		173	W
Storage Temperature	$T_{stg}$		-65 to +175	deg.C
Channel Temperature	$T_{ch}$		250	deg.C

### RECOMMENDED OPERATING CONDITION

Item	Symbol	Condition	Limit	Unit
DC Input Voltage	$V_{DS}$		$\leq 55$	V
Forward Gate Current	$I_{GF}$	$RG=10ohm$	$\leq 204$	mA
Reverse Gate Current	$I_{GR}$	$RG=10ohm$	$\geq -7.8$	mA
Channel Temperature	$T_{ch}$		$\leq 180$	deg.C
Average Output Power	$P_{ave}$		$\leq 50.5$	dBm

### ELECTRICAL CHARACTERISTICS ( Case Temperature $T_c=25deg.C$ )

Item	Symbol	Condition	Limit			Unit
			Min.	Typ.	Max.	
Pinch-Off Voltage	$V_p$	$V_{DS}=50V, I_{DS}=54.4mA$	-1.0	-1.5	-2.0	V
Saturated Power	$P_{sat} *1$	$V_{DS}=50V$	52.5	53.5	-	dBm
Drain Efficiency	$\eta_d *2$	$I_{DS}(DC)=750mA$	30.0	35.0	-	%
Power Gain	$G_p *2$	$f=0.9GHz$	16.5	17.5	-	dB
Thermal Resistance	$R_{th}$	Channel to Case at 105W PDC	-	1.1	1.3	deg.C/W

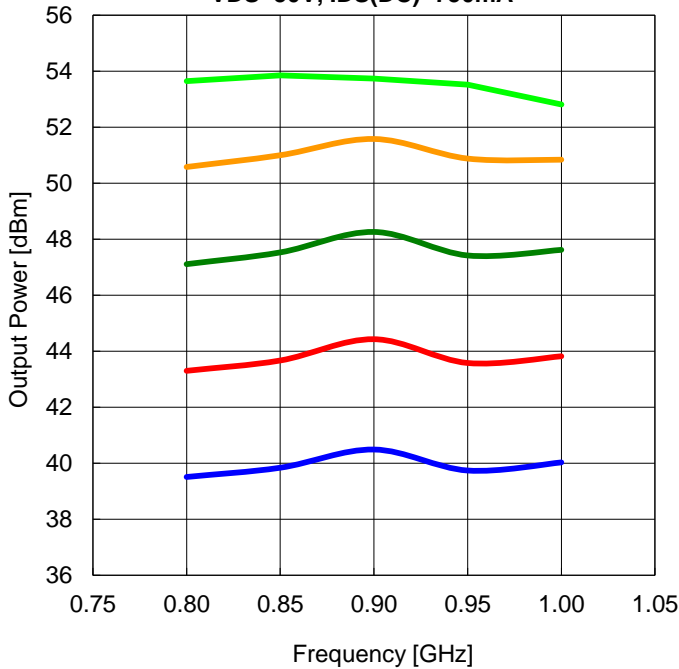
\*1 : 10%-duty RF pulse ( DC supply constant )

\*2 :  $P_{out}=45.5dBm$ , CW modulation Signal ( W-CDMA )

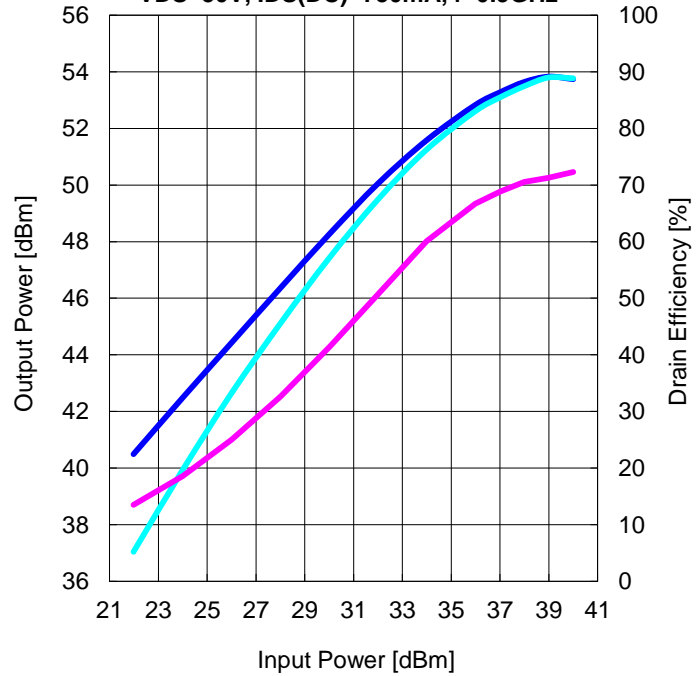
RoHS COMPLIANCE	Yes
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### RF characteristics @f=0.9GHz fine tuned

Output Power vs. Frequency  
VDS=50V, IDS(DC)=750mA



Output Power and Drain Efficiency vs. Input Power  
VDS=50V, IDS(DC)=750mA, f=0.9GHz

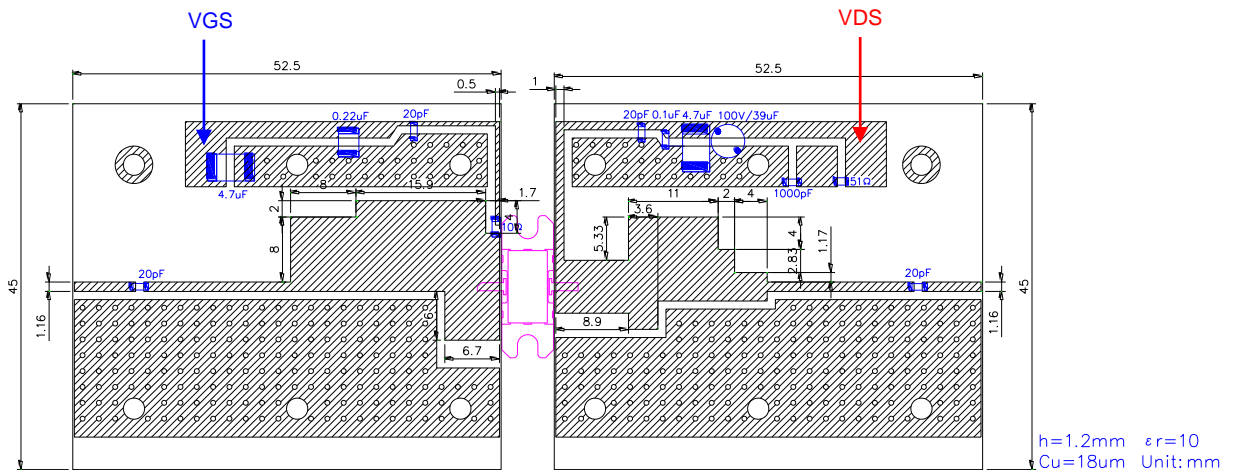


— Pin=22dBm    — Pin=26dBm    — Pin=30dBm  
— Pin=34dBm    — Pin=40dBm

— Pout (class AB)    — Pout (class B)    — Nd (class B)

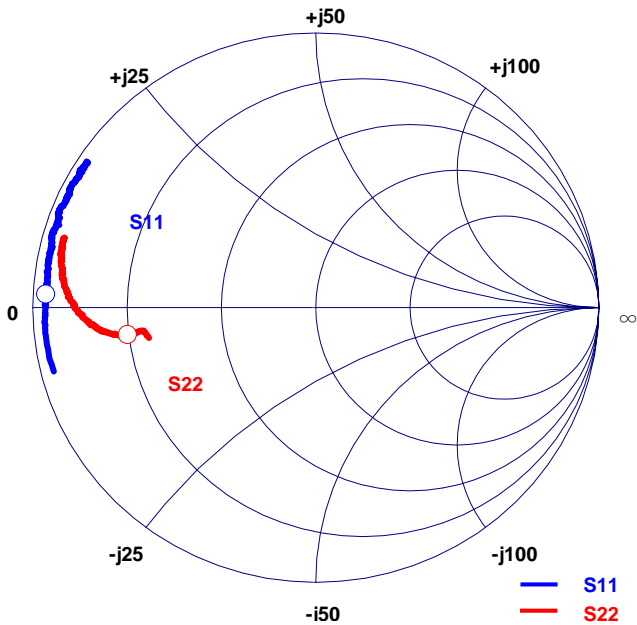
### Test Fixture

Pulse Signal (10%-duty, DC : constant)

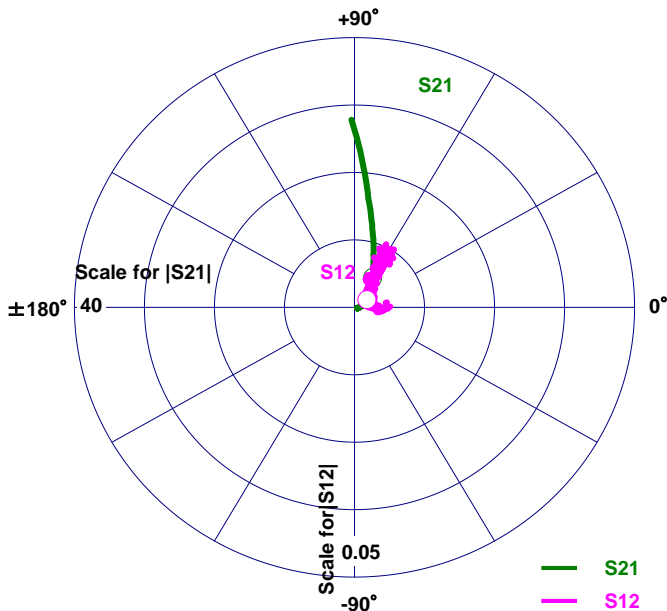


S-Parameters @VDS=50V, IDS(DC)=750mA, f=0.1 to 3.1GHz  
 ZI = Zs = 50ohm Marker : 0.9GHz

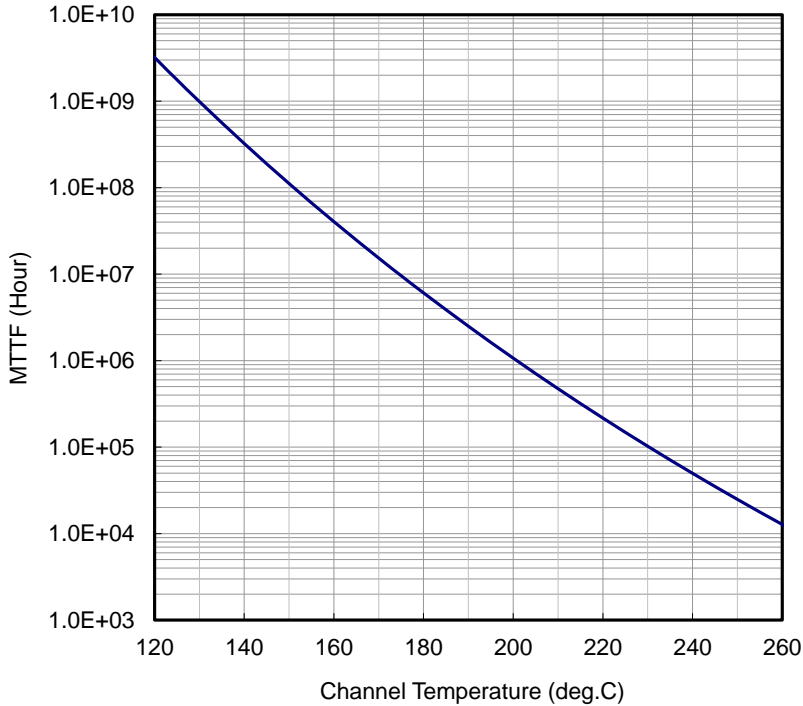
- Reference DATA -



Freq. GHz	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
0.10	0.95	-165.90	27.83	90.90	0.006	8.58	0.60	-169.34
0.20	0.96	-175.14	13.80	80.16	0.006	-2.63	0.61	-172.14
0.30	0.96	-178.79	9.00	72.37	0.005	-10.90	0.63	-172.17
0.40	0.96	-178.94	6.57	65.98	0.004	-12.44	0.65	-171.64
0.50	0.96	-177.02	5.12	59.50	0.00	5.22	0.67	-171.64
0.60	0.95	-175.57	4.10	53.64	0.00	1.56	0.70	-171.69
0.70	0.96	-173.88	3.42	48.57	0.00	15.36	0.72	-172.04
0.80	0.96	-172.65	2.88	43.52	0.00	10.67	0.74	-172.90
0.90	0.95	-171.37	2.44	39.30	0.00	32.92	0.76	-173.47
1.00	0.96	-170.34	2.12	34.77	0.00	25.90	0.78	-174.56
1.10	0.96	-168.89	1.86	30.61	0.00	33.74	0.80	-175.37
1.20	0.96	-167.09	1.64	25.97	0.00	37.75	0.81	-176.78
1.30	0.96	-165.77	1.45	22.15	0.00	56.77	0.83	-177.97
1.40	0.97	-164.81	1.31	19.21	0.00	57.87	0.84	-179.02
1.50	0.97	-164.02	1.19	15.65	0.00	46.32	0.85	-179.92
1.60	0.97	-162.57	1.06	12.77	0.01	55.59	0.86	-178.54
1.70	0.96	-161.31	0.97	9.84	0.01	60.79	0.88	-177.41
1.80	0.96	-160.13	0.88	6.47	0.01	55.92	0.88	-176.52
1.90	0.97	-159.35	0.81	3.90	0.01	57.28	0.89	-175.33
2.00	0.97	-158.04	0.77	0.99	0.01	64.84	0.89	-174.14
2.10	0.97	-157.46	0.70	-0.64	0.01	61.03	0.90	-173.19
2.20	0.96	-155.94	0.65	-3.62	0.01	65.23	0.90	-172.08
2.30	0.97	-154.89	0.59	-5.51	0.01	57.95	0.90	-171.17
2.40	0.97	-153.78	0.58	-7.72	0.01	57.21	0.91	-170.24
2.50	0.97	-152.56	0.55	-11.47	0.01	65.35	0.91	-169.16
2.60	0.96	-151.39	0.51	-12.90	0.01	62.47	0.92	-168.35
2.70	0.96	-150.31	0.48	-13.83	0.01	64.34	0.92	-167.40
2.80	0.96	-149.27	0.45	-17.35	0.01	59.26	0.92	-166.43
2.90	0.96	-148.74	0.43	-16.58	0.01	61.84	0.92	-165.34
3.00	0.96	-147.61	0.43	-20.21	0.01	57.04	0.93	-164.47
3.10	0.97	-146.74	0.41	-20.73	0.01	62.67	0.93	-164.02



**MTTF Calculation  
- Estimated MTTF -**



**Ea=1.6eV  
Confidence Level=90%**

Channel Temp. ( deg.C )	MTTF ( Hours )
160	4.05 x 10 <sup>7</sup>
180	6.07 x 10 <sup>6</sup>
200	1.07 x 10 <sup>6</sup>

$$AF = \exp\left[\frac{-Ea}{k}\left(\frac{1}{T_{stress}} - \frac{1}{T_{use}}\right)\right]$$

$$MTTF_{use} = MTTF_{stress} \times AF$$

Where;

AF : acceleration factor

Ea : activation energy (1.6eV)

k : Boltzmann's constant (8.62x10<sup>-5</sup>eV/K)

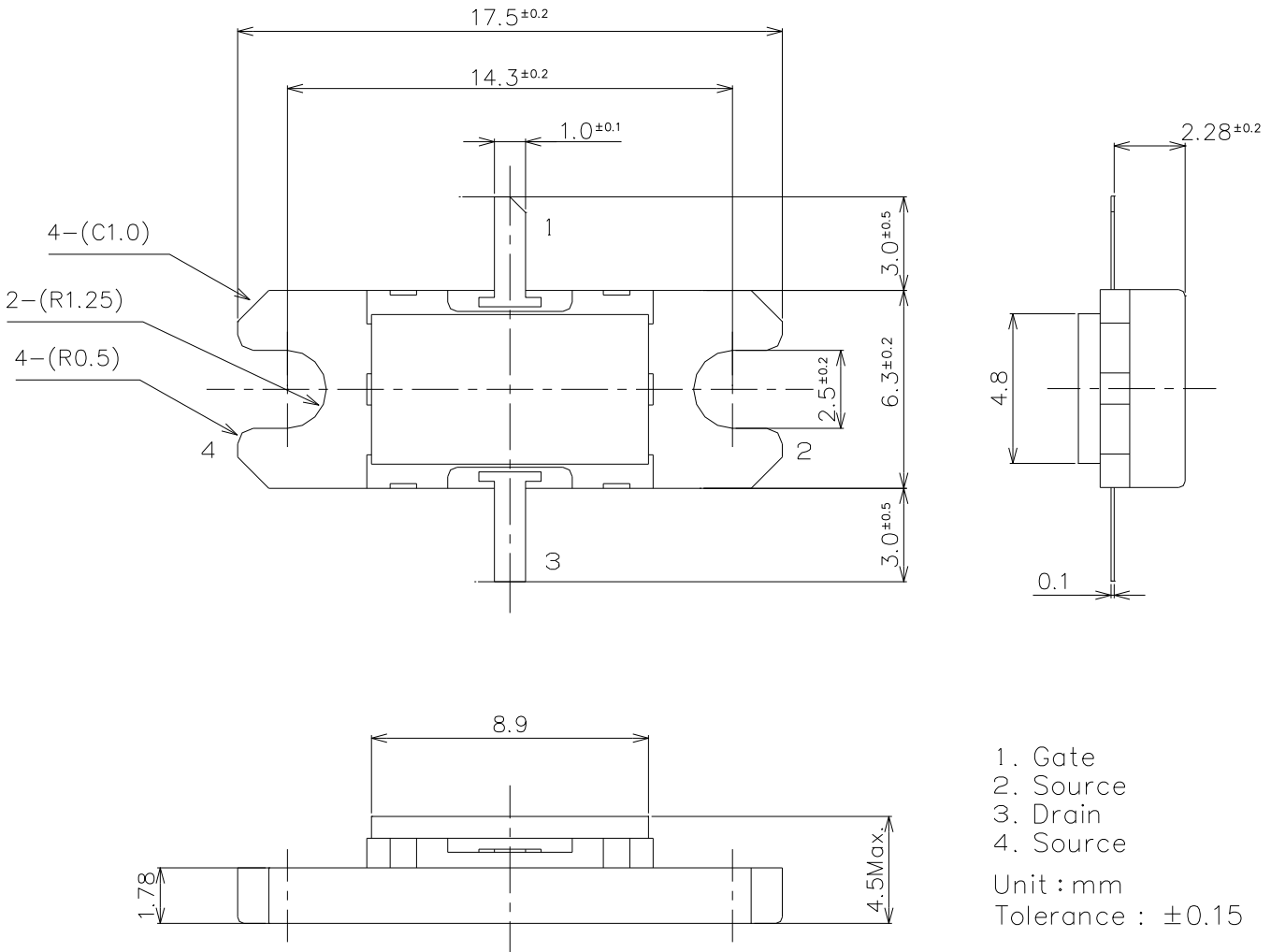
T<sub>stress</sub> : stress temperature (K)

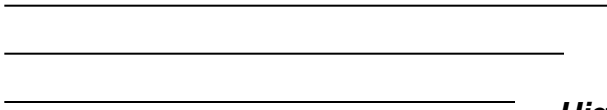
T<sub>use</sub> : use temperature (K)

### ESD characteristic

Test Methodology	Class
Human Body Model (per JESD22-A114)	1B
Machine Model (per JEIA/ESD22-A115)	A

### MK Package Outline Metal-Ceramic Hermetic Package





# **EGNC210MK**

***High Voltage - High Power GaN-HEMT***

**For further information please contact:**

**<http://global-sei.com/Electro-optic/about/office.html>**